

Application Data Sheet

Application Information

Application Type::	Regular
Subject Matter::	Utility
Title::	Stacked Semiconductor Die Assembly
Attorney Docket Number::	B-00002
Request for Early Publication?::	No
Request for Non-Publication?::	Yes
Suggested Drawing Figure::	1A
Total Drawing Sheets::	78
Small Entity::	No
Petition included?::	No
Secrecy Order in Parent Appl.?::	No

Inventor Information

Inventor Authority type::	Inventor
Primary Citizenship Country::	US
Status::	Full Capacity
Given Name::	Roger
Middle Name::	D.
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State or Province::	AZ
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Inventor Authority type::	Inventor
Primary Citizenship Country::	US
Status::	Full Capacity
Given Name::	Vladimir
Family Name::	Perelman
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Assignee Information

Assignee Name:: Amkor Technology, Inc.